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Kind regards,
Team Nexperia

## CBT3384

## 10-bit bus switch with 5-bit output enables

## 1. General description

The CBT3384 provides ten bits of high-speed TTL-compatible bus switching. The low ON resistance of the switch allows connections to be made with minimal propagation delay.

The CBT3384 device is organized as two 5 -bit bus switches with two separate output enable ( $1 \overline{\mathrm{OE}}, 2 \overline{\mathrm{OE}}$ ) inputs. When n $\overline{\mathrm{OE}}$ is LOW, the switch is on and port $A$ is connected to the $B$ port. When $n \overline{O E}$ is HIGH, each switch is disabled.

The CBT3384 is characterized for operation from $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$.

## 2. Features

- $5 \Omega$ switch connection between two ports
- TTL-compatible control input levels
- Multiple package options

■ See CBTD3384 for CBT3384 with level shifting diodes

- Latch-up protection exceeds 100 mA per JESD78

■ ESD protection:

- HBM JESD22-A114E exceeds 2000 V
- CDM JESD22-C101C exceeds 1000 V


## 3. Ordering information

Table 1. Ordering information

| Type number | Package |  |  |  |
| :---: | :---: | :---: | :---: | :---: |
|  | Temperature range | Name | Description | Version |
| CBT3384D | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | SO24 | plastic small outline package; 24 leads; body width 7.5 mm | SOT137-1 |
| CBT3384DB | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | SSOP24 | plastic shrink small outline package; 24 leads; body width 5.3 mm | SOT340-1 |
| CBT3384DK | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | SSOP24[1] | plastic shrink small outline package; 24 leads; body width 3.9 mm ; lead pitch 0.635 mm | SOT556-1 |
| CBT3384PW | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | TSSOP24 | plastic thin shrink small outline package; 24 leads; body width 4.4 mm | SOT355-1 |

[^0]
## 4. Functional diagram



Fig 1. Logic diagram

## 5. Pinning information

### 5.1 Pinning




Fig 4. Pin configuration for SSOP24 (SOT556-1)

### 5.2 Pin description

Table 2. Pin description

| Symbol | Pin | Description |
| :---: | :---: | :---: |
| 10E, 2 $\overline{O E}$ | 1,13 | output enable input (active LOW) |
| 1A1 to 1A5 | 3, 4, 7, 8, 11 | data input/output (A port) |
| 2A1 to 2A5 | 14, 17, 18, 21, 22 | data input/output (A port) |
| 1 B 1 to 1B5 | 2, 5, 6, 9, 10 | data input/output (B port) |
| 2B1 to 2B5 | 15, 16, 19, 20, 23 | data input/output (B port) |
| GND | 12 | ground (0 V) |
| $\mathrm{V}_{\text {CC }}$ | 24 | positive supply voltage |

## 6. Functional description

Table 3. Function selection[]

| Input |  | Input/output |  |
| :--- | :--- | :--- | :--- |
| $\mathbf{1 0 E}$ | $\mathbf{2 O E}$ | $\mathbf{1 A n}, \mathbf{1 B n}$ | 2An, 2Bn |
| L | L | $1 \mathrm{An}=1 \mathrm{Bn}$ | $2 \mathrm{An}=2 \mathrm{Bn}$ |
| L | H | $1 \mathrm{An}=1 \mathrm{Bn}$ | Z |
| H | L | Z | $2 \mathrm{An}=2 \mathrm{Bn}$ |
| H | H | Z | Z |

[1] $\mathrm{H}=\mathrm{HIGH}$ voltage level; $\mathrm{L}=\mathrm{LOW}$ voltage level; $\mathrm{Z}=$ high-impedance OFF-state.

## 7. Limiting values

Table 4. Limiting values In accordance with the Absolute Maximum Rating System (IEC 60134).[1] $T_{\text {amb }}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$, unless otherwise specified.

| Symbol | Parameter | Conditions | Min | Max | Unit |
| :--- | :--- | :--- | :--- | :--- | :--- |
| $\mathrm{V}_{\mathrm{CC}}$ | supply voltage |  | -0.5 | +7.0 | V |
| $\mathrm{~V}_{\mathrm{I}}$ | input voltage | $\mathrm{V}_{\mathrm{O}}<0 \mathrm{~V}$ | $\underline{[2]}$ | -0.5 | +7.0 |
| $\mathrm{I}_{\mathrm{O}}$ | output current | $\mathrm{V}_{I / \mathrm{O}}=0 \mathrm{~V}$ | - | $\pm$ |  |
| $\mathrm{I}_{\mathrm{IK}}$ | input clamping current |  | -50 | - | V |
| $\mathrm{T}_{\text {stg }}$ | storage temperature | -65 | +150 | ${ }^{\circ} \mathrm{C}$ |  |

[1] Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under Section 8. is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability
[2] The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

## 8. Recommended operating conditions

Table 5. Operating conditions
All unused control inputs of the device must be held at $V_{C C}$ or GND to ensure proper device operation.

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| $\mathrm{V}_{\mathrm{CC}}$ | supply voltage | 4.5 | - | 5.5 | V |  |
| $\mathrm{~V}_{\text {IH }}$ | HIGH-state input voltage |  | 2.0 | - | - | V |
| $\mathrm{V}_{\text {IL }}$ | LOW-state input voltage |  | - | - | 0.8 | V |
| $\mathrm{~T}_{\text {amb }}$ | ambient temperature | operating in free air | -40 | - | +85 | ${ }^{\circ} \mathrm{C}$ |

## 9. Static characteristics

Table 6. Static characteristics
Voltages are referenced to GND (ground = 0 V ).

| Symbol | Parameter | Conditions | $\mathrm{T}_{\text {amb }}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Typ[1] | Max |  |
| $\mathrm{V}_{\text {IK }}$ | input clamping voltage | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V} ; \mathrm{I}_{\mathrm{I}}=-18 \mathrm{~mA}$ | - | - | -1.2 | V |
| 1 | input leakage current | $\mathrm{V}_{C C}=5.5 \mathrm{~V} ; \mathrm{V}_{\mathrm{I}}=\mathrm{GND}$ or 5.5 V | - | - | $\pm 1$ | $\mu \mathrm{A}$ |
| ICC | supply current | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=5.5 \mathrm{~V} ; \mathrm{I}_{\mathrm{O}}=0 \mathrm{~mA} ; \\ & \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{CC}} \text { or } \mathrm{GND} \end{aligned}$ | - | - | 3 | $\mu \mathrm{A}$ |
| $\Delta l_{\text {CC }}$ | additional supply current | per input pin; $\mathrm{V}_{\mathrm{CC}}=5.5 \mathrm{~V}$; one input at [2] 3.4 V , other inputs at $\mathrm{V}_{\mathrm{CC}}$ or GND | - | - | 2.5 | mA |
| $V_{\text {pass }}$ | pass voltage | $\begin{aligned} & \text { output } \mathrm{HIGH} ; \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V} \text {; } \\ & \mathrm{I}_{\mathrm{O}}=-100 \mu \mathrm{~A} \end{aligned}$ | 3.6 | 3.9 | 4.2 | V |
| $\mathrm{C}_{1}$ | input capacitance | control pins; $\mathrm{V}_{1}=3 \mathrm{~V}$ or 0 V | - | 4.0 | - | pF |
| $\mathrm{C}_{\mathrm{io} \text { (off) }}$ | off-state input/output capacitance | port off; $\mathrm{V}_{\mathrm{I}}=3 \mathrm{~V}$ or 0 V ; $\mathrm{nOE}=\mathrm{V}_{\mathrm{CC}}$ | - | 10.0 | - | pF |

Table 6. Static characteristics ...continued
Voltages are referenced to GND (ground = 0 V ).

| Symbol | Parameter | Conditions |  | $\mathrm{T}_{\text {amb }}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min | Typ[1] | Max |  |
| Ron | ON resistance | $\mathrm{V}_{\text {CC }}=4.5 \mathrm{~V} ; \mathrm{V}_{\mathrm{I}}=0 \mathrm{~V} ; \mathrm{I}_{\mathrm{I}}=64 \mathrm{~mA}$ | [3] | - | 5 | 7 | $\Omega$ |
|  |  | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V} ; \mathrm{V}_{\mathrm{I}}=0 \mathrm{~V} ; \mathrm{I}_{\mathrm{I}}=30 \mathrm{~mA}$ | [3] | - | 5 | 7 | $\Omega$ |
|  |  | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V} ; \mathrm{V}_{\mathrm{I}}=2.4 \mathrm{~V} ; \mathrm{I}_{\mathrm{I}}=-15 \mathrm{~mA}$ | [3] | - | 10 | 15 | $\Omega$ |

[1] All typical values are at $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{amb}}=25^{\circ} \mathrm{C}$.
[2] This is the increase in supply current for each input that is at the specified TTL voltage level rather than $\mathrm{V}_{\mathrm{CC}}$ or GND.
[3] Measured by the voltage drop between the nAn and the nBn terminals at the indicated current through the switch. ON resistance is determined by the lowest voltage of the two ( $n A n$ or $n B n$ ) terminals.

## 10. Dynamic characteristics

Table 7. Dynamic characteristics
Voltages are referenced to GND (ground $=0$ V). For test circuit see Figure 7.

| Symbol | Parameter | Conditions |  | $\mathrm{T}_{\mathrm{amb}}=25^{\circ} \mathrm{C}$ |  |  | $\mathrm{T}_{\text {amb }}=-40^{\circ} \mathrm{C}$ to +85 ${ }^{\circ} \mathrm{C}$ |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min | Typ | Max | Min | Max |  |
| $t_{\text {pd }}$ | propagation delay | nAn, nBn to nBn, nAn; see Figure 5 | [1][2] |  |  |  |  |  |  |
|  |  | $\mathrm{V}_{C C}=5.0 \mathrm{~V} \pm 0.5 \mathrm{~V}$ |  | - | - | 0.25 | - | 0.25 | ns |
| $\mathrm{t}_{\text {PZH }}$ | OFF-state to HIGH propagation delay | $n \overline{O E}$ to $n A n$ or $n B n$; see Figure 6 |  |  |  |  |  |  |  |
|  |  | $\mathrm{V}_{C C}=5.0 \mathrm{~V} \pm 0.5 \mathrm{~V}$ |  | 1.2 | 2.3 | 5.7 | 1.2 | 5.6 | ns |
| $t_{\text {PZL }}$ | OFF-state to LOW propagation delay | nOE to nAn or nBn; see Figure 6 |  |  |  |  |  |  |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V} \pm 0.5 \mathrm{~V}$ |  | 1.2 | 2.3 | 5.7 | 1.2 | 6.0 | ns |
| $\mathrm{t}_{\text {PHZ }}$ | HIGH to OFF-state propagation delay | n $\overline{O E}$ to $n A n$ or $n B n$; see Figure 6 |  |  |  |  |  |  |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V} \pm 0.5 \mathrm{~V}$ |  | 1.7 | 3.6 | 5.2 | 1.7 | 5.5 | ns |
| $t_{\text {PLZ }}$ | LOW to OFF-state propagation delay | nOE to $n A n$ or $n B n$; see Figure 6 |  |  |  |  |  |  |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V} \pm 0.5 \mathrm{~V}$ |  | 1.7 | 2.7 | 5.2 | 1.7 | 6.6 | ns |

[1] The propagation delay is the calculated RC time constant of the typical ON resistance of the switch and the specified load capacitance, when driven by an ideal voltage source (zero output impedance).
[2] $t_{p d}$ is the same as $t_{P L H}$ and $t_{P H L}$.

## 11. Waveforms



Measurement points are given in Table 8.
Logic levels: $\mathrm{V}_{\mathrm{OL}}$ and $\mathrm{V}_{\mathrm{OH}}$ are typical output voltage levels that occur with the output load.
Fig 5. The data input ( $\mathrm{nAn}, \mathrm{nBn}$ ) to output ( $\mathrm{nBn}, \mathrm{nAn}$ ) propagation delay times


Measurement points are given in Table 8.
Logic levels: $\mathrm{V}_{\mathrm{OL}}$ and $\mathrm{V}_{\mathrm{OH}}$ are typical output voltage levels that occur with the output load.
Fig 6. Enable and disable times

Table 8. Measurement points

| Supply voltage | Input | Output |  |  |  |
| :--- | :--- | :--- | :--- | :--- | :--- |
| $\mathbf{V}_{\mathbf{c C}}$ | $\mathbf{V}_{\mathbf{I}}$ | $\mathbf{V}_{\mathbf{M}}$ | $\mathbf{V}_{\mathbf{M}}$ | $\mathbf{V}_{\mathbf{X}}$ | $\mathbf{V}_{\mathbf{Y}}$ |
| $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V} \pm 0.5 \mathrm{~V}$ | GND to 3.0 V | 1.5 V | 1.5 V | $\mathrm{~V}_{\mathrm{OL}}+0.3 \mathrm{~V}$ | $\mathrm{~V}_{\mathrm{OH}}-0.3 \mathrm{~V}$ |

## 12. Test information



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Test data is given in Table 9.
All input pulses are supplied by generators having the following characteristics: PRR $\leq 10 \mathrm{MHz} ; \mathrm{Z}_{0}=50 \Omega$
The outputs are measured one at a time with one transition per measurement
Definitions for test circuit:
$R_{\mathrm{L}}=$ Load resistance.
$\mathrm{C}_{\mathrm{L}}=$ Load capacitance including jig and probe capacitance
$R_{T}=$ Termination resistance should be equal to output impedance $Z_{o}$ of the pulse generator.
$\mathrm{V}_{\mathrm{EXT}}=$ External voltage for measuring switching times
Fig 7. Test circuit for measuring switching times

Table 9. Test data

| Supply voltage | Input |  | Load |  | $\mathrm{V}_{\text {EXT }}$ |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | $V_{1}$ | $\mathbf{t r}_{\mathbf{r}}, \mathbf{t}_{\text {f }}$ | $\mathrm{C}_{\mathrm{L}}$ | $\mathbf{R}_{\mathrm{L}}$ | $\mathrm{t}_{\text {PLH }}, \mathrm{t}_{\text {PHL }}$ | $t_{\text {PLZ }}, \mathrm{t}_{\text {PZL }}$ | $\mathbf{t}_{\text {PHZ }}$, $\mathbf{t}_{\text {PzH }}$ |
| $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V} \pm 0.5 \mathrm{~V}$ | GND to 3.0 V | $\leq 2.5 \mathrm{~ns}$ | 50 pF | $500 \Omega$ | open | 7.0 V | open |

## 13. Package outline



| UNIT | $\begin{gathered} \mathrm{A} \\ \max . \end{gathered}$ | $\mathrm{A}_{1}$ | $\mathrm{A}_{2}$ | $\mathrm{A}_{3}$ | $\mathrm{b}_{\mathrm{p}}$ | c | $\mathrm{D}^{(1)}$ | $E^{(1)}$ | e | $\mathrm{H}_{\mathrm{E}}$ | L | $L_{p}$ | Q | v | w | y | $\mathrm{Z}^{(1)}$ | $\theta$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| mm | 2.65 | $\begin{aligned} & 0.3 \\ & 0.1 \end{aligned}$ | $\begin{aligned} & 2.45 \\ & 2.25 \end{aligned}$ | 0.25 | $\begin{aligned} & 0.49 \\ & 0.36 \end{aligned}$ | $\begin{aligned} & 0.32 \\ & 0.23 \end{aligned}$ | $\begin{aligned} & \hline 15.6 \\ & 15.2 \end{aligned}$ | $\begin{aligned} & 7.6 \\ & 7.4 \end{aligned}$ | 1.27 | $\begin{aligned} & 10.65 \\ & 10.00 \end{aligned}$ | 1.4 | $\begin{aligned} & 1.1 \\ & 0.4 \end{aligned}$ | $\begin{aligned} & 1.1 \\ & 1.0 \end{aligned}$ | 0.25 | 0.25 | 0.1 | $\begin{aligned} & 0.9 \\ & 0.4 \end{aligned}$ | $8^{\circ}$ |
| inches | 0.1 | $\begin{aligned} & 0.012 \\ & 0.004 \end{aligned}$ | $\begin{array}{\|l\|} \hline 0.096 \\ 0.089 \end{array}$ | 0.01 | $\begin{aligned} & 0.019 \\ & 0.014 \end{aligned}$ | $\begin{aligned} & 0.013 \\ & 0.009 \end{aligned}$ | $\begin{aligned} & 0.61 \\ & 0.60 \end{aligned}$ | $\begin{aligned} & 0.30 \\ & 0.29 \end{aligned}$ | 0.05 | $\begin{aligned} & 0.419 \\ & 0.394 \end{aligned}$ | 0.055 | $\begin{array}{\|l\|} \hline 0.043 \\ 0.016 \end{array}$ | $\begin{aligned} & 0.043 \\ & 0.039 \end{aligned}$ | 0.01 | 0.01 | 0.004 | $\begin{aligned} & 0.035 \\ & 0.016 \end{aligned}$ | $0^{\circ}$ |

Note

1. Plastic or metal protrusions of $0.15 \mathrm{~mm}(0.006 \mathrm{inch})$ maximum per side are not included.

| OUTLINE <br> VERSION | REFERENCES |  |  | EUROPEAN PROJECTION | ISSUE DATE |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | IEC | JEDEC | JEITA |  |  |
| SOT137-1 | 075E05 | MS-013 |  | $\square$ | $\begin{array}{r} \hline-1227 \\ 03-02-19 \end{array}$ |

Fig 8. Package outline SOT137-1 (SO24)
DIMENSIONS (mm are the original dimensions)

| UNIT | A max. | $\mathrm{A}_{1}$ | $\mathrm{A}_{2}$ | $\mathrm{A}_{3}$ | $\mathrm{b}_{\mathrm{p}}$ | c | $D^{(1)}$ | $E^{(1)}$ | e | $\mathrm{H}_{\mathrm{E}}$ | L | $L_{p}$ | Q | v | w | y | $\mathrm{Z}^{(1)}$ | $\theta$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| mm | 2 | 0.21 | 1.80 | 0.25 | 0.38 | 0.20 | 8.4 | 5.4 | 0.65 | 7.9 | 1.25 | 1.03 | 0.9 | 0.2 | 0.13 | 0.1 | 0.8 | $8{ }^{\circ}$ |
|  |  | 0.05 | 1.65 |  | 0.25 | 0.09 | 8.0 | 5.2 |  | 7.6 |  | 0.63 | 0.7 |  |  |  | 0.4 | $0^{\circ}$ |

Note

1. Plastic or metal protrusions of 0.2 mm maximum per side are not included.

| OUTLINE <br> VERSION | REFERENCES |  |  |  | EUROPEAN <br> PROJECTION | ISSUE DATE |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | IEC | JEDEC | JEITA |  |  | $-99-12-27$ <br> $03-02-19$ |

Fig 9. Package outline SOT340-1 (SSOP24)


DIMENSIONS (millimetre dimensions are derived from the original inch dimensions)

| UNIT | $\begin{gathered} \mathrm{A} \\ \max . \end{gathered}$ | $\mathrm{A}_{1}$ | $\mathrm{A}_{2}$ | $\mathrm{A}_{3}$ | $\mathrm{b}_{\mathrm{p}}$ | c | $D^{(1)}$ | $\mathrm{E}^{(1)}$ | e | $\mathrm{H}_{\mathrm{E}}$ | L | $L_{p}$ | v | w | y | $\mathrm{Z}^{(1)}$ | $\theta$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| mm | 1.73 | $\begin{aligned} & 0.25 \\ & 0.10 \end{aligned}$ | $\begin{aligned} & 1.55 \\ & 1.40 \end{aligned}$ | 0.25 | $\begin{aligned} & 0.31 \\ & 0.20 \end{aligned}$ | $\begin{aligned} & 0.25 \\ & 0.18 \end{aligned}$ | $\begin{aligned} & 8.8 \\ & 8.6 \end{aligned}$ | $\begin{aligned} & 4.0 \\ & 3.8 \end{aligned}$ | 0.635 | $\begin{aligned} & 6.2 \\ & 5.8 \end{aligned}$ | 1 | $\begin{aligned} & 0.89 \\ & 0.41 \end{aligned}$ | 0.25 | 0.18 | 0.1 | $\begin{aligned} & 1.05 \\ & 0.66 \end{aligned}$ | $8^{8}{ }^{\circ}$ |
| inches | 0.068 | $\begin{array}{\|l\|} 0.0098 \\ 0.0040 \end{array}$ | $\begin{aligned} & 0.061 \\ & 0.055 \end{aligned}$ | 0.01 | $\begin{aligned} & 0.012 \\ & 0.008 \end{aligned}$ | $\begin{array}{\|l\|} 0.0098 \\ 0.0075 \end{array}$ | $\begin{aligned} & 0.344 \\ & 0.337 \end{aligned}$ | $\begin{aligned} & 0.157 \\ & 0.150 \end{aligned}$ | 0.025 | $\begin{aligned} & 0.244 \\ & 0.228 \end{aligned}$ | 0.041 | $\begin{aligned} & 0.035 \\ & 0.016 \end{aligned}$ | 0.01 | 0.007 | 0.004 | $\begin{aligned} & 0.040 \\ & 0.026 \end{aligned}$ | $8^{\circ}$ $0^{\circ}$ |

Note

1. Plastic or metal protrusions of 0.2 mm ( 0.008 inch ) maximum per side are not included.

| OUTLINE VERSION | REFERENCES |  |  | EUROPEAN PROJECTION | ISSUE DATE |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | IEC | JEDEC | JEITA |  |  |
| SOT556-1 |  | MO-137 |  | $\bigcirc$ | $\begin{aligned} & 99-12-27 \\ & 03-02-18 \end{aligned}$ |

Fig 10. Package outline SOT556-1 (SSOP24)

DIMENSIONS (mm are the original dimensions)

| UNIT | $\mathbf{A}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathbf{m a x}$. |  | $\mathbf{A}_{\mathbf{1}} \quad \mathbf{A}_{\mathbf{2}} \quad \mathbf{A}_{\mathbf{3}} \quad \mathbf{b}_{\mathbf{p}} \quad \mathbf{c}$

Notes

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

| OUTLINE <br> VERSION | REFERENCES |  |  |  | EUROPEAN <br> PROJECTION | ISSUE DATE |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | IEC | JEDEC | JEITA |  |  | - |
| SOT355-1 |  | MO-153 |  |  | $-99-12-27$ <br> $03-02-19 ~$ |  |

Fig 11. Package outline SOT355-1 (TSSOP24)

## 14. Abbreviations

Table 10. Abbreviations

| Acronym | Description |
| :--- | :--- |
| CDM | Charged Device Model |
| DUT | Device Under Test |
| ESD | ElectroStatic Discharge |
| FET | Field Effect Transistor |
| HBM | Human Body Model |
| PRR | Pulse Rate Repetition |
| TTL | Transistor-Transistor Logic |

## 15. Revision history

Table 11. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
| :--- | :--- | :--- | :--- | :--- |
| CBT3384_6 | 20091102 | Product data sheet | - | CBT3384_5 |
| Modifications: | - The format of this data sheet has been redesigned to comply with the new identity guidelines of |  |  |  |
|  |  |  |  |  |
|  |  | NXP Semiconductors. |  |  |
|  |  | - Changed: Table 6 "Static characteristics" |  |  |

a. Pass voltage values have changed.
b. Undershoot static current protection removed.

- Changed: Table 7 "Dynamic characteristics"
a. Enable and disable times values have changed.

| CBT3384_5 | 20011220 | Product specification | - | CBT3384_4 |
| :--- | :--- | :--- | :--- | :--- |
| CBT3384_4 | 20010319 | Product specification | - | CBT3384_3 |
| CBT3384_3 | 20001113 | Product specification | - | CBT3384_2 |
| CBT3384_2 | 20000128 | Product specification | - | - |

## 16. Legal information

### 16.1 Data sheet status

| Document status $[\underline{[1][2]}$ | Product status $[3]$ | Definition |
| :--- | :--- | :--- |
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.
[2] The term 'short data sheet' is explained in section "Definitions".
[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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18. Contents
1 General description ..... 1
2 Features ..... 1
3 Ordering information ..... 1
4 Functional diagram ..... 2
5 Pinning information ..... 2
5.1 Pinning ..... 2
5.2 Pin description ..... 3
6 Functional description ..... 3
7 Limiting values ..... 4
8 Recommended operating conditions. ..... 4
9 Static characteristics. ..... 4
10 Dynamic characteristics ..... 5
11 Waveforms ..... 6
12 Test information ..... 7
13 Package outline ..... 8
14 Abbreviations ..... 12
15 Revision history ..... 12
16 Legal information ..... 13
16.1 Data sheet status ..... 13
16.2 Definitions ..... 13
16.3 Disclaimers ..... 13
16.4 Trademarks ..... 13
17 Contact information ..... 13
18 Contents ..... 14

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[^0]:    [1] Also known as QSOP24 package

